Inverter

Rev. 4 — 2 October 2013

1. General description

The 74HC3G04; 74HCT3G04 is a triple inverter. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- Input levels:
 - ◆ For 74HC3G04: CMOS level
 - For 74HCT3G04: TTL level
- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- Multiple package options
- ESD protection:
 - HBM JESD22-A114E exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1.Ordering information

Type number	Package	Package							
	Temperature range	Name	Description	Version					
74HC3G04DP	–40 °C to +125 °C	TSSOP8							
74HCT3G04DP			body width 3 mm; lead length 0.5 mm						
74HC3G04DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads;	SOT765-1					
74HCT3G04DC			body width 2.3 mm						
74HC3G04GD	–40 °C to +125 °C	XSON8							
74HCT3G04GD			8 terminals; body $3 \times 2 \times 0.5$ mm						

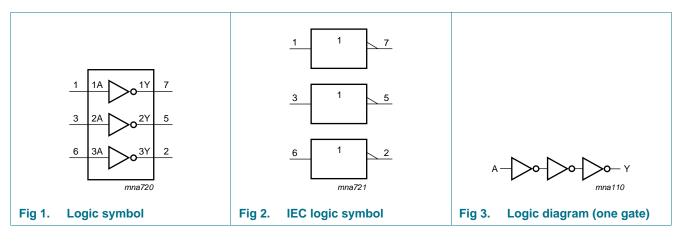


4. Marking

Table 2. Marking codes	
Type number	Marking code ^[1]
74HC3G04DP	H04
74HCT3G04DP	T04
74HC3G04DC	H04
74HCT3G04DC	T04
74HC3G04GD	H04
74HCT3G04GD	T04

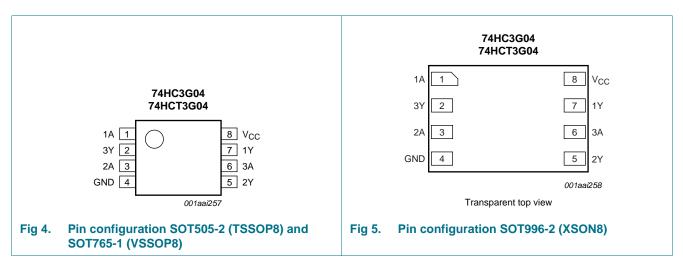
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin des	scription	
Symbol	Pin	Description
1A, 2A, 3A	1, 3, 6	data input
GND	4	ground (0 V)
1Y, 2Y, 3Y	7, 5, 2	data output
V _{CC}	8	supply voltage

7. Functional description

Table 4. Function table ^[1]	
Input	Output
nA	nY
L	Н
Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				0	,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V_{I} < -0.5 V or V_{I} > V_{CC} + 0.5 V	<u>[1]</u> _	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	V_{O} = -0.5 V to (V _{CC} + 0.5 V)	<u>[1]</u> _	25	mA
I _{CC}	supply current		<u>[1]</u> _	50	mA
I _{GND}	ground current		<u>[1]</u> –50	-	mA
T _{stg}	storage temperature		-65	+150	°C
PD	dynamic power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[2] _	300	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 package: above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K. For VSSOP8 package: above 110 °C the value of P_{tot} derates linearly with 8 mW/K. For XSON8 package: above 45 °C the value of P_{tot} derates linearly with 2.4 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter Conditions		7	4HC3G0	4	74HCT3G04			Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
and	and fall rate	$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 7.Static characteristics

Voltages are referenced to GND (ground = 0 V). All typical values are measured at T_{amb} = 25 °C.

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	−40 °C 1	to +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC3G	04									
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH} HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$									
	output voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		I_{O} = -4.0 mA; V_{CC} = 4.5 V	4.18	4.32	-	4.13	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.68	5.81	-	5.63	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	per input pin; $V_{CC} = 6.0 V$; $V_I = V_{CC}$ or GND; $I_O = 0 A$;	-	-	1.0	-	10	-	20	μA

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	_40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
CI	input capacitance		-	1.5	-	-	-	-	-	pF
74HCT3	G04									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH} HIGH-level		$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.18	4.32	-	4.13	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_O = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	-	0	0.1	-	0.1	-	0.1	V
		I_0 = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	per input pin; $V_{CC} = 5.5 \text{ V}$; $V_I = V_{CC} \text{ or GND}$; $I_O = 0 \text{ A}$;	-	-	1.0	-	10	-	20	μA
Δl _{CC}	additional supply current	per input; $V_{CC} = 4.5 V \text{ to } 5.5 V;$ $V_I = V_{CC} - 2.1 V; I_O = 0 A$	-	-	300	-	375	-	410	μA
Cı	input capacitance		-	1.5	-	-	-	-	-	pF

Table 7. Static characteristics ...continued

Voltages are referenced to GND (ground = 0 V). All typical values are measured at $T_{amb} = 25$ °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); all typical values are measured at $T_{amb} = 25 \text{ }^{\circ}\text{C}$; for test circuit see Figure 7.

Symbol	Parameter	Conditions		25 °C			-40 °C to	o +85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max		
74HC3G	04										
t _{pd} propagation	propagation	nA to nY; see Figure 6	[1]								
	delay	$V_{CC} = 2.0 V$		-	22	75	-	90	-	110	ns
		$V_{CC} = 4.5 V$		-	8	15	-	18	-	22	ns
		$V_{CC} = 6.0 V$		-	6	13	-	16	-	20	ns
t _t	transition	see Figure 6	[2]								
	time	$V_{CC} = 2.0 V$		-	18	75	-	95	-	125	ns
		$V_{CC} = 4.5 V$		-	6	15	-	19	-	25	ns
		$V_{CC} = 6.0 V$		-	5	13	-	16	-	20	ns
C _{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC}	<u>[3]</u>	-	9	-	-	-	-	-	pF

74HC_HCT3G04
Product data sheet

Inverter

Table 8.	Dynamic	characteristics	continued
	bynanio	on a dotor lotioo	

Voltages are referenced to GND (ground = 0 V); all typical values are measured at $T_{amb} = 25 \,^{\circ}$ C; for test circuit see Figure 7.

Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit	
				Min	Тур	Max	Min	Max	Min	Max	
74HCT3	G04										
t _{pd}	1 1 0	nA to nY; see Figure 6	[1]								
	delay	$V_{CC} = 4.5 V$		-	10	18	-	23	-	29	ns
t _t	transition time	V_{CC} = 4.5 V; see <u>Figure 6</u>	[2]	-	6	15	-	19	-	22	ns
C _{PD}	power dissipation capacitance	V_{I} = GND to V_{CC} – 1.5 V	<u>[3]</u>	-	9	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

- $\label{eq:ttime_time} [2] \quad t_t \text{ is the same as } t_{TLH} \text{ and } t_{THL}.$
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}{}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}{}^{2} \times f_{o}) \text{ where:}$

f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o) = sum \ of \ outputs.$

12. Waveforms

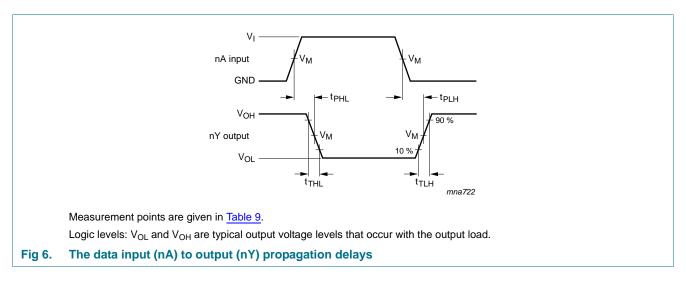


Table 9. Measurement points

Туре	Input	Output
	V _M	V _M
74HC3G04	$0.5 imes V_{CC}$	$0.5 \times V_{CC}$
74HCT3G04	1.3 V	1.3 V

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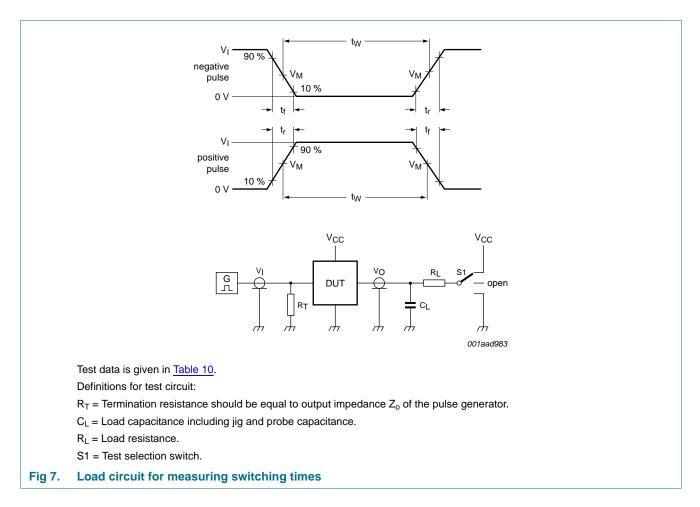


Table 10. Test data

Туре	Input		Load		S1 position
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}
74HC3G04	V _{CC}	≤ 6 ns	50 pF	1 kΩ	open
74HCT3G04	3 V	≤ 6 ns	50 pF	1 kΩ	open

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13. Package outline

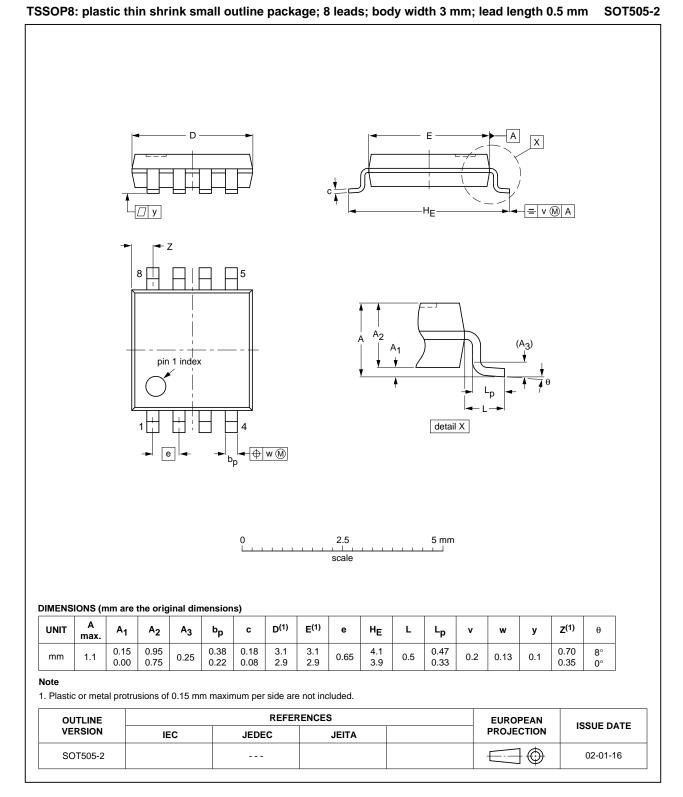


Fig 8. Package outline SOT505-2 (TSSOP8)

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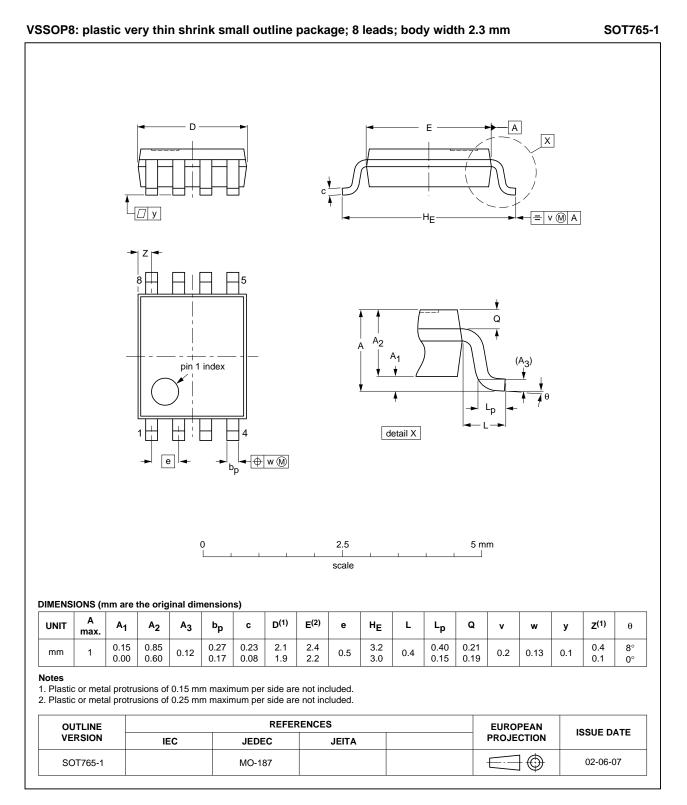
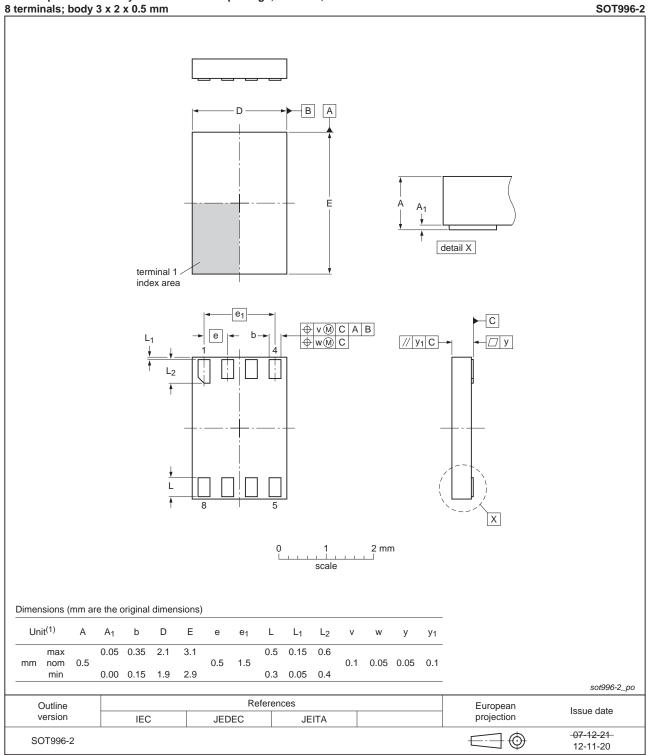


Fig 9. Package outline SOT765-1 (VSSOP8)

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XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 3 x 2 x 0.5 mm

Fig 10. Package outline SOT996-2 (XSON8)

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14. Abbreviations

Table 11. A	bbreviations
Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 12. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT3G04 v.4	20131002	Product data sheet	-	74HC_HCT3G04 v.3
Modifications:	 For type null 	mbers 74HC3G04GD and 7	74HCT3G04GD XSON8	U has changed to XSON8.
74HC_HCT3G04 v.3	20080702	Product data sheet	-	74HC_HCT3G04 v.2
74HC_HCT3G04 v.2	20031030	Product specification	-	74HC_HCT3G04 v.1
74HC_HCT3G04 v.1	20020726	Product specification	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
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18. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 1
4	Marking 2
5	Functional diagram 2
6	Pinning information 2
6.1	Pinning 2
6.2	Pin description 3
7	Functional description 3
8	Limiting values 3
9	Recommended operating conditions 4
10	Static characteristics 4
11	Dynamic characteristics 5
12	Waveforms 6
13	Package outline 8
14	Abbreviations 11
15	Revision history 11
16	Legal information
16.1	Data sheet status 12
16.2	Definitions 12
16.3	Disclaimers
16.4	Trademarks
17	Contact information 13
18	Contents 14

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